

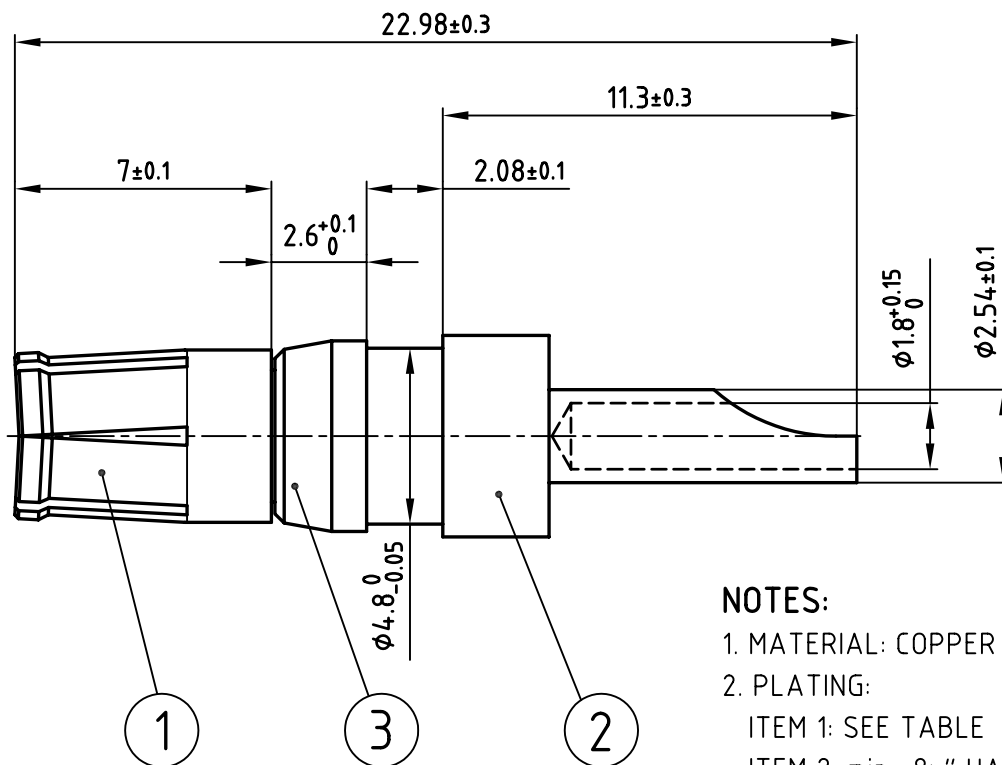
4

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2

1

used for: D-SUB COMBINATION



NOTES:

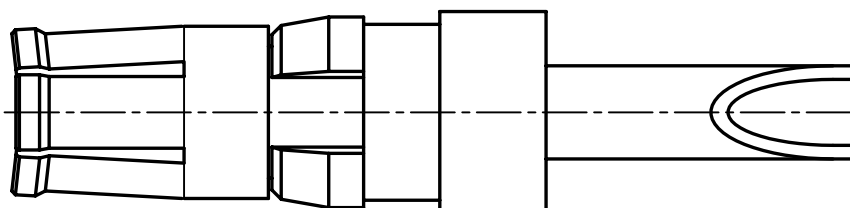
1. MATERIAL: COPPER ALLOY

2. PLATING:

ITEM 1: SEE TABLE

ITEM 2: min. 8µ" HARD GOLD
OVER min. 50µ" NICKEL

ITEM 3: NICKEL PLATED



Plating item 1	Part-NO. CONEC
min. 30µ" HARD GOLD OVER min. 50µ" NICKEL	132C10019X
min. 50µ" HARD GOLD OVER min. 50µ" NICKEL	132J10019X

Directive 2002/95/EC
"RoHS"
Compliant

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				tolerance ISO 2768-m		
				1998	date	name
				drawn	23.03.	Barcinski
				appd.	23.03.	Mickenbecker
				norm		
				d-old	SK211H10	
						
rev.	description	date	name			

CONEC®scale: 5:1
material: SEE NOTEStitle:
HIGH POWER CONTACT FEMALE
SOLDER CUP 10A
D-SUB COMBINATIONdwg no: 13K1IE3A
product no: SEE TABLE

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